

Electronic Patent Application Fee Transmittal

Application Number:	10512405			
Filing Date:	15-Jun-2005			
Title of Invention:	HIGH RESISTANCE SILICON WAFER AND ITS MANUFACTURING METHOD			
First Named Inventor/Applicant Name:	Nobumitsu Takase			
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Attorney Docket Number:	474082002800			
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
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Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1440	1440
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Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Printed copy of patent - no color	8001	6	3	18
Total in USD (\$)				1758